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OKUZAWA et al.(10) **Pub. No.: US 2023/0230756 A1**(43) **Pub. Date: Jul. 20, 2023**(54) **LAMINATED COIL COMPONENT**(71) Applicant: **TDK CORPORATION**, Tokyo (JP)(72) Inventors: **Nobuyuki OKUZAWA**, Tokyo (JP);
Munehiro TAKAKU, Tokyo (JP);
Kazuya TOBITA, Tokyo (JP);
Teruhiro MITSUYASU, Tokyo (JP)(73) Assignee: **TDK CORPORATION**, Tokyo (JP)(21) Appl. No.: **18/153,659**(22) Filed: **Jan. 12, 2023**(30) **Foreign Application Priority Data**

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2027/2809 (2013.01)(57) **ABSTRACT**

A laminated coil component includes an element body, a first terminal electrode and a second terminal electrode, and a coil, the coil includes a plurality of first wiring portions disposed on a main surface side and disposed side by side in a third direction, a plurality of second wiring portions disposed on a mounting surface side and disposed side by side in the third direction, and a plurality of first pillar portions and second pillar portions that extend in a second direction and connect the first wiring portion with the second wiring portion which correspond to each other, and a width of the second wiring portion in the third direction is smaller than a width of the first wiring portion in the third direction.

